

Pulsed Laser Diode Series CVLL Series

1550nm High Brightness

Advanced Photonix offers a family of extremely high brightness CVLL 1550nm pulsed laser diodes capable of up to 25 Watts output power. These devices are well suited to most range finding applications requiring "eye safe" operation.

Applications

Range-finding

Hunting

Targeting

Surveying

Features

Low Divergence / High Brightness

Stable Output from -40°C to +85°C

Hermetically Sealed Package

RoHS Compliant

Warning: Diode laser emissions can be hazardous to eyesight. Standard aversion responses, such as blinking or turning away, are insufficient protection against the potential radiation risks of these devices. Do not directly view the laser aperture during operation. Lasers at 1310nm are classified as IEC Class 3R, while lasers with higher wavelengths fall under Class 1 when used within their specified conditions.

Absolute Maximum Ratings at $T_A=25\text{ }^\circ\text{C}$

Parameter	Symbol	Min	Max	Unit
Operating Temperature	T_{OP}	-40	+85	$^\circ\text{C}$
Storage Temperature	T_{STG}	-40	+85	$^\circ\text{C}$
Package		9mm		

Typical Electro-Optical Specifications at $T_A=25\text{ }^\circ\text{C}$

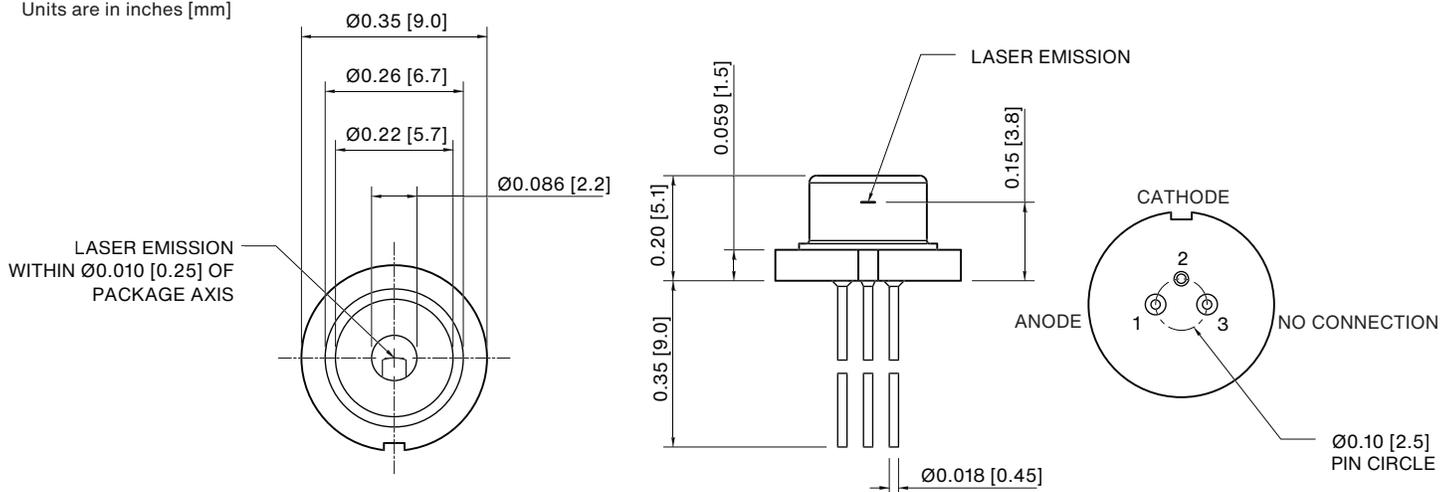
Parameter	Symbol	Min	Typ	Max	Unit
Peak Wavelength	λ	1530	1550	1580	nm
Spectral Width	$\Delta\lambda$	-	15	-	nm
Temperature Coefficient of Wavelength	$\Delta\lambda / \Delta T$	-	0.55	-	nm / $^\circ\text{C}$
Beam Divergence	FWHM	-	10x24	-	Degree
Pulse Width	PW	-	150	-	ns
Duty Factor	DF	-	0.07	-	%
Rise Time	T_r	-	1	-	ns
Fall Time	T_f	-	1	-	ns

Test Conditions: Pulse width = 150nS, Rep. Rate = 5kHz, 25°C

Parameter	Symbol	CVLL 95-90	CVLL 350-90	Unit
Minimum Peak Power	P_o	10	25	W
Peak Forward Current	I_f	30	75	A
Typical Threshold Current	I_{th}	1	2	A
Number of Diodes	-	1	1	-
Typical Emitting Area	-	95 x 1	350 x 1	μm

Mechanical Specification

Units are in inches [mm]



General Care and Handling Instructions

Photodiodes:

Handling and Storage

- Handle Photodiodes gently to prevent damage.
- Avoid exposing Photodiodes to temperatures exceeding the storage temperature rating of the device.
- Maintain a non-condensing environment for optimum performance and lifetime.

Cleaning

- Gently clean the glass (borosilicate or quartz window) using a 50/50 mixture of Methanol and isopropyl alcohol and a soft, optical-grade pad.

Special Considerations for Plastic or Epoxy Encapsulated Photodiodes

- Protect from intense light sources such as direct sunlight.
- Avoid exposure to harsh chemicals like THINNERS, ACETONE, and TRICHLOROETHYLENE.
- Cleaning with a 50/50 mixture of Methanol and isopropyl alcohol (IPA) is recommended. Cleaning in an ultrasonic bath is generally not recommended.

CdS Photocells:

Handling and Storage

- Handle CdS Photocells gently to prevent damage.
- Avoid exposing CdS Photocells to temperatures exceeding the storage temperature rating of the device.
- Maintain a non-condensing environment for optimum performance and lifetime.

Cleaning

- Gently clean the glass or plastic covering using a 50/50 mixture of Methanol and isopropyl alcohol and a soft, optical-grade pad.

Special Considerations

- DO NOT use Vapor Phase Soldering or Reflow Soldering for CdS components.

Optocouplers and LEDs:

Handling and Storage

- Handle Optocouplers and LEDs gently to prevent damage.
- Avoid exposing the devices to temperatures exceeding the storage temperature rating of the device.
- Maintain a non-condensing environment for optimum performance and lifetime.

Cleaning

- For plastic molded devices, cleaning with a 50/50 mixture of Methanol and isopropyl alcohol is recommended. Cleaning in an ultrasonic bath is generally not recommended.

Special Considerations

- Avoid exposing plastic molded devices or epoxy glob top devices to harsh chemicals like THINNERS, ACETONE, and TRICHLOROETHYLENE.

Electrostatic Discharge (ESD) Sensitivity:

- All devices are considered ESD-sensitive. They are shipped in ESD protective packaging. When unpacking and using these products, anti-ESD precautions should be observed.

Lead Trimming and Bending:

- Standard lead trimming after soldering is an acceptable practice; however, do not attempt to bend or modify the leads incorrectly, as it can damage the glass feed-through or the plastic encapsulant.

Soldering Instructions:

- Use a soldering iron with a tip temperature of 300°C max.
- Consult with your preferred solder manufacturer to determine a solder alloy and flux combination, as well as the reflow profile appropriate for your application.

General Precautions for all Devices

1. Moisture Prevention:

Ensure devices are stored in a dry environment to prevent moisture ingress, which can cause damage during soldering. Refer to J-STD-20 for guidance on proper baking procedures to prevent moisture related damage.

2. Lead Splaying:

If required, carefully splay the leads of the devices according to the specific application needs. Be cautious when splaying leads, as improper techniques may damage the device. Consult technical support or device datasheets for guidance on lead splaying.

3. Mechanical Stress:

Handle devices with care throughout the installation process to prevent damage.

4. Circuit Protection and Layout:

Optimize the circuit design and layout to ensure proper functioning and prevent damage to the devices. Include appropriate protection measures like ESD protection diodes, current-limiting resistors, and voltage regulation.

5. After-Sale Support:

For troubleshooting and device-specific inquiries, please consult with our technical support team. They can offer valuable guidance and suggestions on handling, operation, and application-related questions. To reach them, please contact the Advanced Photonix Applications group at Techsupport@advancedphotonix.com.

Legal Disclaimer

Information in this data sheet is believed to be correct and reliable. However, no responsibility is assumed for possible inaccuracies or omission. Specifications are subject to change without notice.

